

## 650V N-Channel Super Junction MOSFET

|                |               |              |                |
|----------------|---------------|--------------|----------------|
| <b>Voltage</b> | <b>650 V</b>  | <b>Rdson</b> | <b>180 mΩ</b>  |
| <b>Current</b> | <b>19.7 A</b> | <b>Qg</b>    | <b>34.3 nC</b> |

### Feature:

- $R_{DS(ON)}$  Max,  $V_{GS}@10V$  : 180mΩ
- Body diode with fast recovery characteristics
- With ESD protection, HBM> 2kV
- 100% Avalanche Tested
- 100% Rg Tested
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

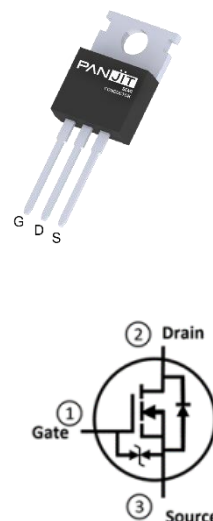
### Mechanical Data

- Case: TO-220AB-L package
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 2.0948 grams

### Application

- TV Power, PC Power, PD Charger, Adapter, UPS

TO-220AB-L



## Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ unless otherwise specified)

| PARAMETER                                        |                         | SYMBOL         | LIMIT    | UNITS            |
|--------------------------------------------------|-------------------------|----------------|----------|------------------|
| Drain-Source Voltage @ $T_{jmax}$                |                         | $V_{DS}$       | 700      | V                |
| Drain-Source Voltage                             |                         | $V_{DS}$       | 650      |                  |
| Gate-Source Voltage                              |                         | $V_{GS}$       | $\pm 20$ |                  |
| Continuous Drain Current                         | $T_C=25^\circ\text{C}$  | $I_D$          | 19.7     | A                |
|                                                  | $T_C=100^\circ\text{C}$ |                | 12.5     |                  |
| Pulsed Drain Current                             | $T_C=25^\circ\text{C}$  | $I_{DM}$       | 47       | A                |
| Single Pulse Avalanche Energy (Note 6)           |                         | $E_{AS}$       | 80       | mJ               |
| MOSFET dv/dt ruggedness                          |                         | dv/dt          | 120      | V/ns             |
| Diode dv/dt                                      |                         | dv/dt          | 70       | V/ns             |
| Power Dissipation                                | $T_C=25^\circ\text{C}$  | $P_D$          | 168.8    | W                |
|                                                  | $T_C=100^\circ\text{C}$ |                | 67.5     |                  |
| Operating Junction and Storage Temperature Range |                         | $T_J, T_{STG}$ | -55~150  | $^\circ\text{C}$ |

### Thermal Characteristics

| PARAMETER          |                              | SYMBOL          | VALUES |      |      | UNITS              |
|--------------------|------------------------------|-----------------|--------|------|------|--------------------|
|                    |                              |                 | MIN.   | TYP. | MAX. |                    |
| Thermal Resistance | Junction-to-Case (Bottom)    | $R_{\theta JC}$ | -      | 0.53 | 0.74 | $^\circ\text{C/W}$ |
|                    | Junction-to-Ambient (Note 3) | $R_{\theta JA}$ | -      | 52.6 | 60   | $^\circ\text{C/W}$ |

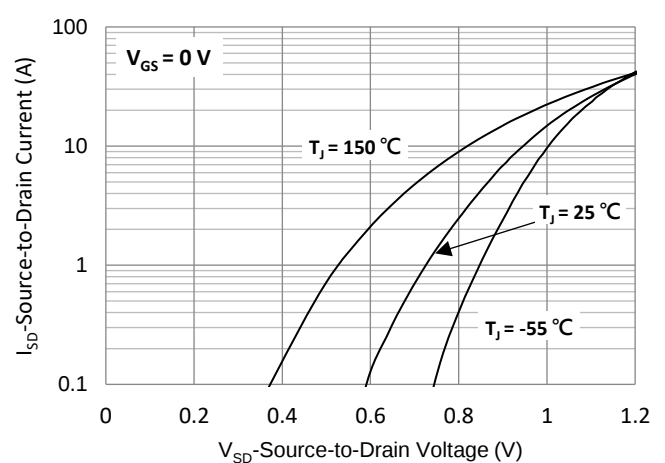
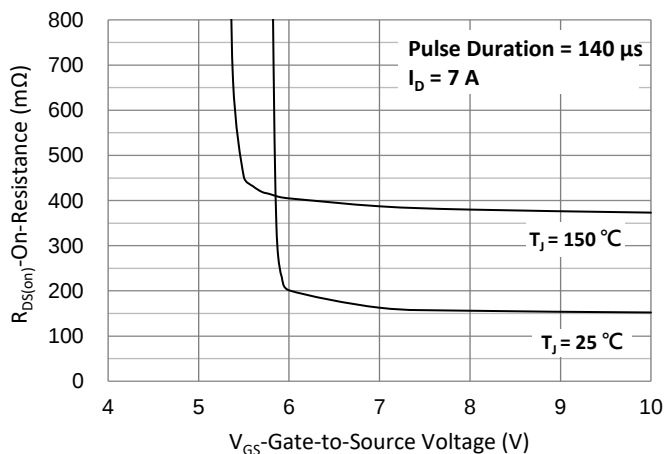
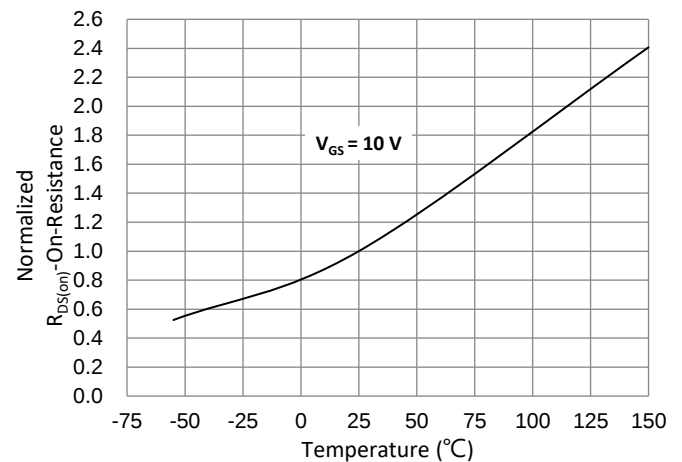
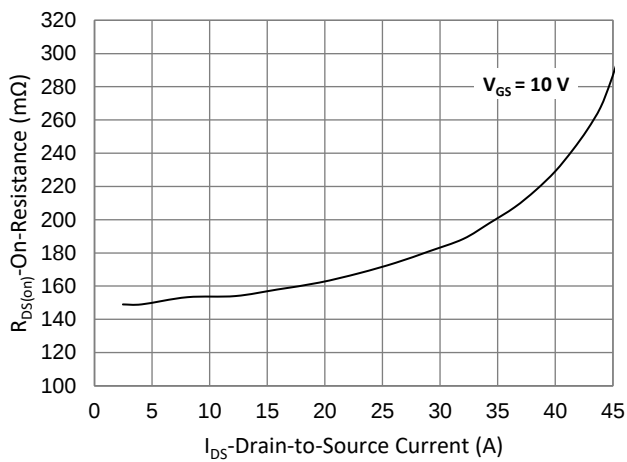
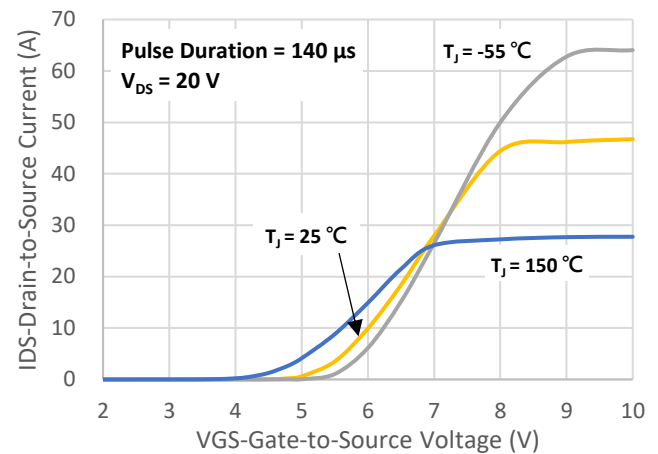
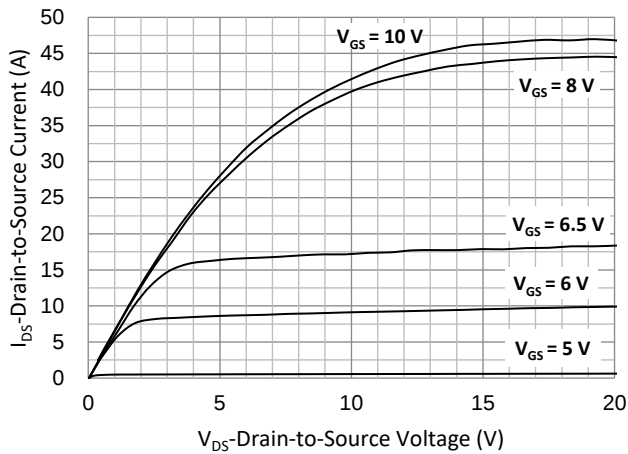
**Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise specified)

| PARAMETER                                                | SYMBOL       | TEST CONDITION                                                    | MIN. | TYP.  | MAX.    | UNITS      |
|----------------------------------------------------------|--------------|-------------------------------------------------------------------|------|-------|---------|------------|
| <b>Static</b>                                            |              |                                                                   |      |       |         |            |
| Drain-Source Breakdown Voltage                           | $BV_{DSS}$   | $V_{GS}=0V, I_D=250\mu A$                                         | 650  | -     | -       | V          |
| Gate Threshold Voltage                                   | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$                                     | 3.3  | 4.0   | 4.7     |            |
| Drain-Source On-State Resistance                         | $R_{DS(on)}$ | $V_{GS}=10V, I_D=7A$ (Note 1)                                     | -    | 156   | 180     | m $\Omega$ |
| Zero Gate Voltage Drain Current                          | $I_{DSS}$    | $V_{DS}=650V, V_{GS}=0V$                                          | -    | -     | 10      | $\mu A$    |
| Gate-Source Leakage Current                              | $I_{GSS}$    | $V_{GS}=\pm 20V, V_{DS}=0V$                                       | -    | -     | $\pm 1$ | $\mu A$    |
| <b>Dynamic</b> (Note 5)                                  |              |                                                                   |      |       |         |            |
| Total Gate Charge                                        | $Q_g$        | $V_{DS}=400V, I_D=14A,$<br>$V_{GS}=10V$                           | -    | 34.3  | -       | nC         |
| Gate-Source Charge                                       | $Q_{gs}$     |                                                                   | -    | 9.7   | -       |            |
| Gate-Drain Charge                                        | $Q_{gd}$     |                                                                   | -    | 14.6  | -       |            |
| Input Capacitance                                        | $C_{iss}$    | $V_{DS}=400V, V_{GS}=0V,$<br>$f=250kHz$                           | -    | 1492  | -       | pF         |
| Output Capacitance                                       | $C_{oss}$    |                                                                   | -    | 22.8  | -       |            |
| Reverse Transfer Capacitance                             | $C_{rss}$    |                                                                   | -    | 3     | -       |            |
| Effective Output Capacitance<br>Energy Related           | $Co(er)$     | $V_{DS}=0V$ to 400V,<br>$V_{GS}=0V$ (Note 4)                      | -    | 44.1  | -       | pF         |
| Turn-On Delay Time                                       | $t_{d(on)}$  | $V_{DD}=400V, I_D=14A,$<br>$V_{GS}=10V, R_G=25\Omega$<br>(Note 2) | -    | 37.7  | -       | ns         |
| Turn-On Rise Time                                        | $t_r$        |                                                                   | -    | 73.1  | -       |            |
| Turn-Off Delay Time                                      | $t_{d(off)}$ |                                                                   | -    | 118.9 | -       |            |
| Turn-Off Fall Time                                       | $t_f$        |                                                                   | -    | 45.7  | -       |            |
| Gate Resistance                                          | $R_g$        | $f=1.0MHz$                                                        | -    | 9.2   | -       | $\Omega$   |
| <b>Drain-Source Diode</b>                                |              |                                                                   |      |       |         |            |
| Maximum Continuous Drain-Source<br>Diode Forward Current | $I_S$        |                                                                   | -    | -     | 19.7    | A          |
| Diode Forward Voltage                                    | $V_{SD}$     | $I_S=7A, V_{GS}=0V$                                               | -    | 0.90  | 1.5     | V          |
| Reverse Recovery Charge                                  | $Q_{rr}$     | $I_S=14A$                                                         | -    | 0.7   | -       | $\mu C$    |
| Reverse Recovery Time                                    | $T_{rr}$     | $di/dt=100A/\mu s$                                                | -    | 129   | -       | ns         |

NOTES :

1. Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ .
2. Essentially independent of operating temperature typical characteristics.
3.  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance.
4.  $C_{o(er)}$  is a capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0V to 400V.
5. Guaranteed by design, not subject to production testing.
6.  $E_{AS}$  is calculated based on the condition of  $L = 10\text{ mH}$ ,  $I_{AS} = 4\text{ A}$ ,  $V_{DD} = 50\text{ V}$ ,  $V_{GS} = 10\text{ V}$ , however by  $0.1\text{mH}$ ,  $I_{AS} = 5.5\text{ A}$  100% test in production.

TYPICAL CHARACTERISTIC CURVES



TYPICAL CHARACTERISTIC CURVES

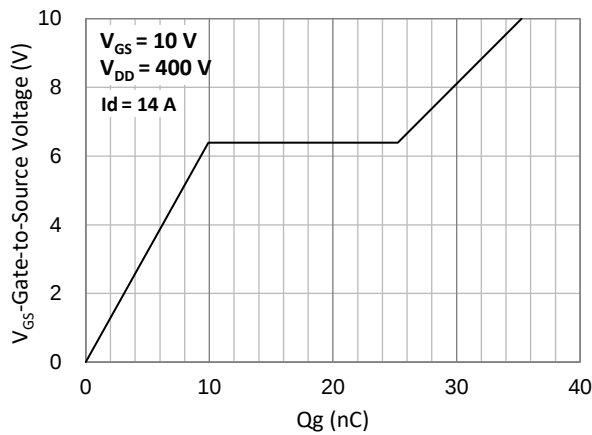


Fig.7 Gate-Charge Characteristics

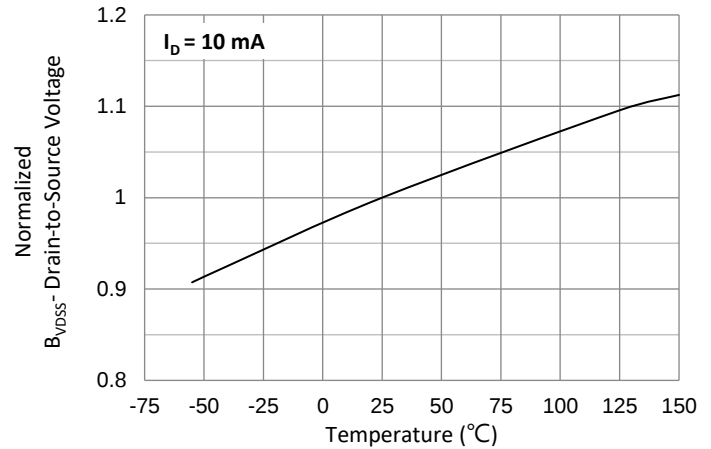


Fig.8 Breakdown Voltage Variation vs. Temperature

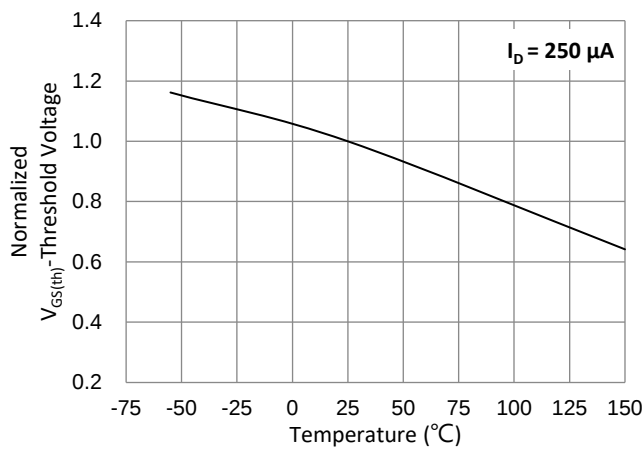


Fig.9 Threshold Voltage Variation with Temperature

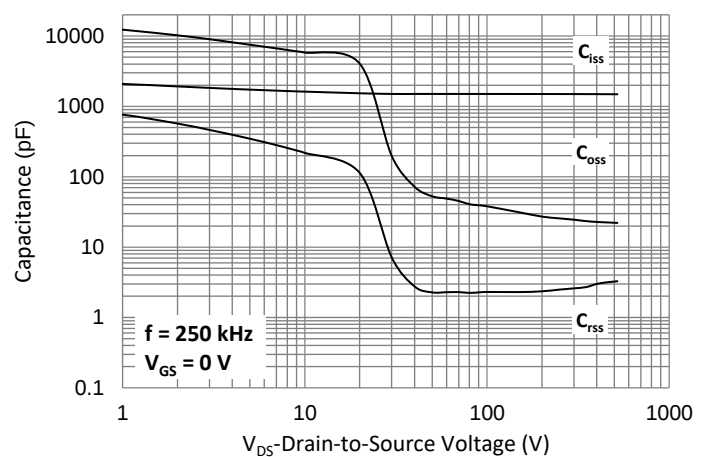


Fig.10 Drain Current vs. Case Temperature

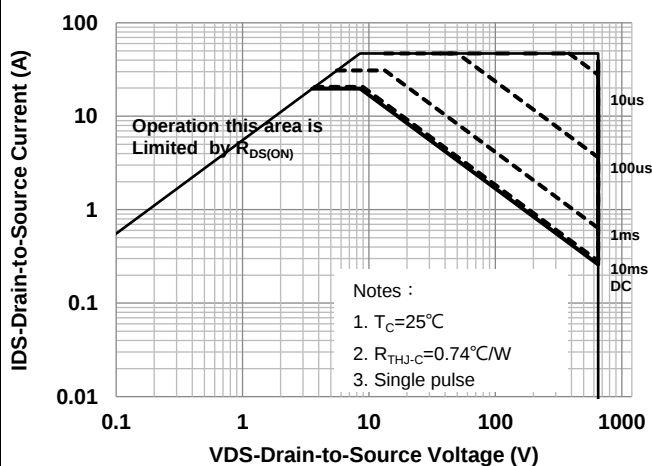


Fig.11 Maximum Safe Operating Area

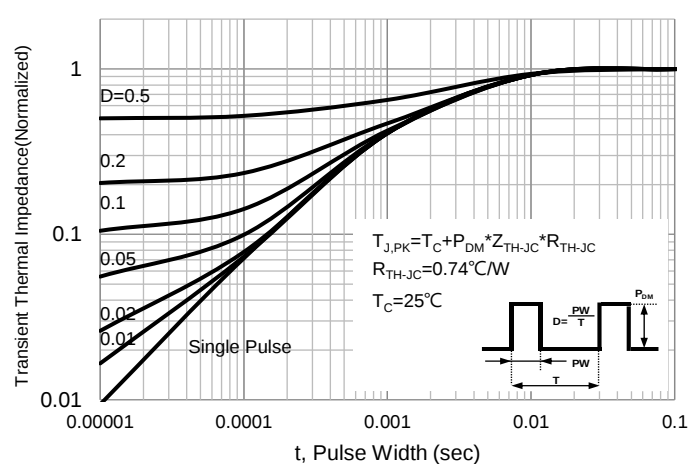
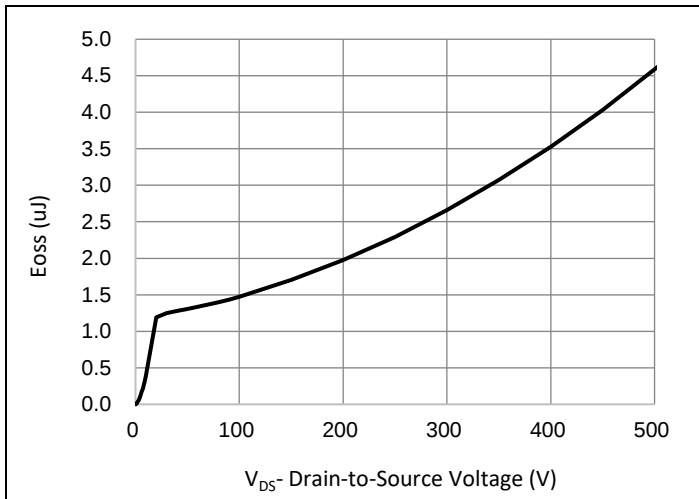


Fig.12 Normalized Transient Thermal Impedance

## TYPICAL CHARACTERISTIC CURVES

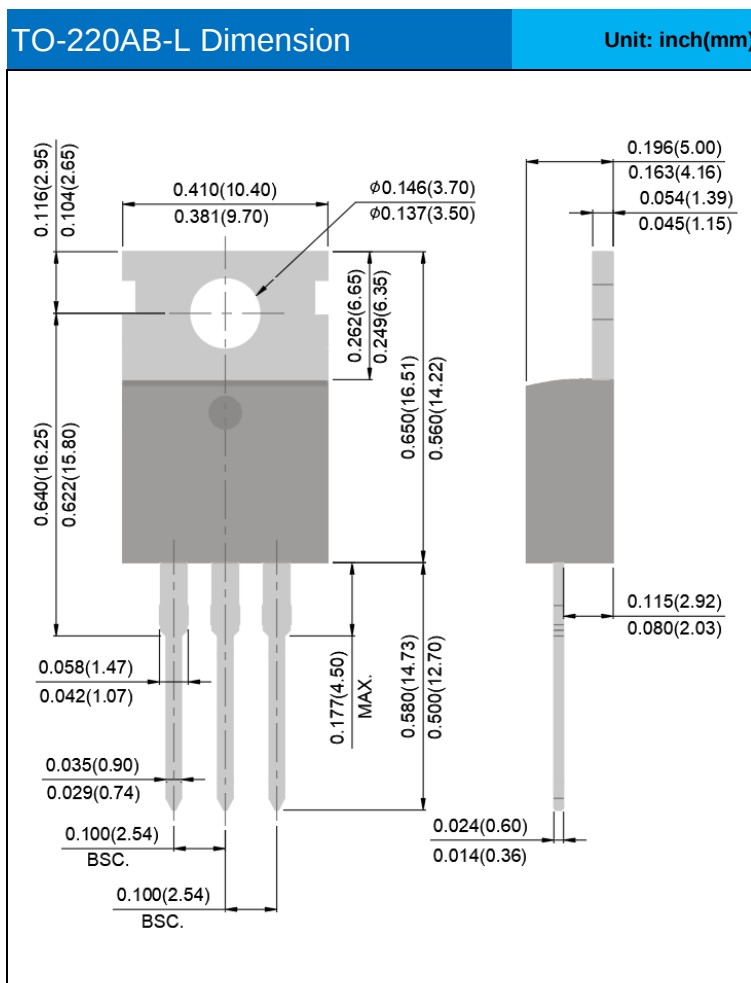


**Fig.13 Typ. Coss Stored Energy**

## Product and Packing Information

| Part No.      | Package Type | Packing Type | Marking   |
|---------------|--------------|--------------|-----------|
| PJMP190N65FR2 | TO-220AB-L   | 50pcs / Tube | 190N65FR2 |

## Packaging Information



## Marking Diagram

|           |                          |
|-----------|--------------------------|
| PJ        | Y = Year Code            |
| 190N65FR2 | W = Week Code (A~Z)      |
| YWLL x    | LL = Lot Code (00~99)    |
|           | x = Production Line Code |

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